

CG/CG2 Series



Agency Approvals

AGENCY	AGENCY FILE NUMBER
	E128662
	E320116

2 Electrode GDT Graphical Symbol



Description

Littelfuse highly reliable CG/CG2 Series GDTs provide a high degree of surge protection in a small size ideal for board level circuit protection.

GDTs function as switches which dissipate a minimum amount of energy and therefore handle currents that far surpass other types of transient voltage protection. Their gas-filled, rugged ceramic metal construction make them well suited to adverse environments.

The CG/CG2 series comes in a variety of forms including surface mount, core, straight and shaped leads, to serve a variety of mounting methods.

The CG Series (75-110V) is ideal for protection of test and communication equipment and other devices in which low voltage limits and extremely low arc voltages are required.

The CG2 Series (145V-1000V) is ideal for protecting equipment where higher voltage limits and holdover voltages are necessary.

Features

- Rugged Ceramic-Metal construction
- Low Capacitance (<1.5pf)
- Meets REA PE-80
- Available in surface mount, and a variety of lead options options

Applications

- Communication lines and equipment
- CATV equipment
- Test equipment
- Data lines
- Power supplies
- Instrumentation circuits
- Medical electronics
- ADSL equipment
- Telecom SLIC protection

Electrical Characteristics

Part Number	Device Specifications (at 25°C)							Life Ratings							
	DC Breakdown in Volts (@100V/s)			Impulse Break-down in Volts (@100V/μs)	Impulse Break-down In Volts (@1 Kv/μsec)	Insulation Resistance	Capacitance (@1MHz)	Arc Voltage (on state Voltage) @1Amp Min	Surge Life (@500A 10/1000μs)	Nominal Impulse Discharge Current (8/20μs)	Nominal AC Discharge Current (10x1sec @50-60Hz)	AC Discharge Current (9 cycle @50Hz)	DC Holdover Voltage ²	Max Impulse Discharge Current (1 Application @ 10/350μs)	
	MIN	TYP	MAX	MAX		MIN	MAX	TYP					TYP		
CG75	60	75	90	400	650	10 ¹⁰ Ω (at 50V)	1.5 pf	15 V	400 shots	10 shots (@20kA) ³	20 A	100 A	52 V	4kA	
CG90	72	90	108	400	600								80 V	2.5kA	
CG90 SN	72	90	108	400	600										
CG110	88	110	132	450	600										
CG2145	116	145	174	500	600										
CG2145 SN	120	145	174	500	600										
CG2230	195	230	265	600	700	135 V									
CG2230 SN	184	230	276	600	700										
CG2250	213	250	288	625	725										
CG2250 SN	200	250	300	625	725										
CG2300	255	300	345	700	800										
CG2300 SN	240	300	360	700	800										
CG2350	297	350	403	750	900										
CG2350 SN	280	350	420	750	900										
CG2420	357	420	483	800	1000										
CG2470	400	470	540	850	1200										
CG2470 SN	376	470	564	850	1200										
CG2600	510	600	690	1000	1400										
CG2600 SN	480	600	720	1000	1400										
CG2800 ¹	680	800	920	1200	1500					10 shots (@10kA)	10 A	65 A			
CG21000 ¹	850	1000	1150	1500	1600										

NOTES:

1. Tested to UL1449 Third Edition

2. Reference REA PE-80, 0.2A. Tested to ITU-T Rec K.12 and REA PE 80 < 150 mSec.

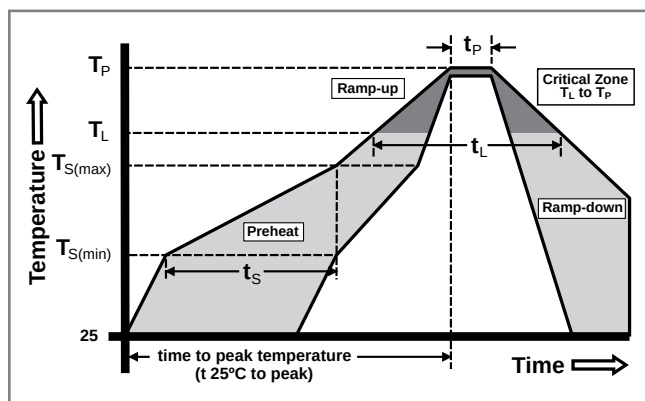
Product Characteristics

Materials	LS, Axial: Device: Tin Plated 2–5 Microns Lead Wires: Tin Plated 17.5 ± 12.5 Microns Construction: Ceramic Insulator Core: Device: Tin Plated 17.5 ± 12.5 Microns. Construction: Ceramic Insulator MS: Device: Dull Tin Plated 7–9 Microns Construction: Ceramic Insulator
Product Marking	LF Logo, Voltage and date code; Black in positive print

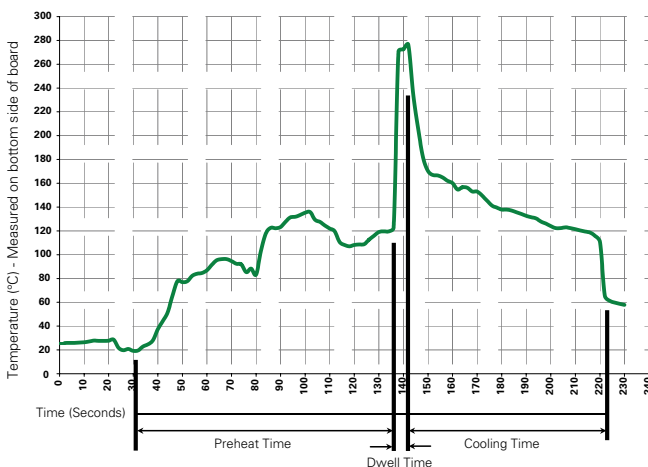
Glow to arc transition current	< 0.5Amps
Glow Voltage	60-160 Volts
Storage and Operational Temperature	-40 to +90
Maximum Follow On Current¹	230 Volts r.m.s, 200 Amps. (800V and 1000V devices tested to UL1449 3rd edition)

Soldering Parameters - Reflow Soldering (Surface Mount Devices)

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (Min to Max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		5°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		10 – 30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		260°C



Soldering Parameters - Wave Soldering (Thru-Hole Devices)



Recommended Process Parameters:

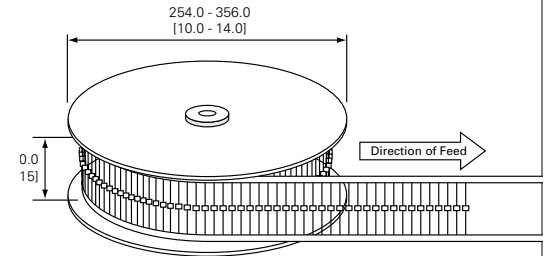
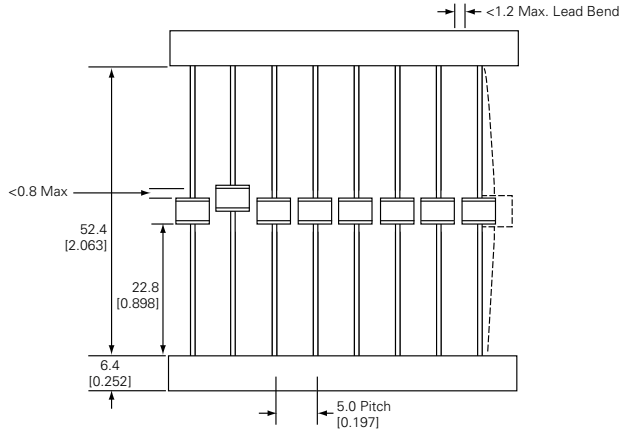
Wave Parameter	Lead-Free Recommendation
Preheat: (Depends on Flux Activation Temperature) (Typical Industry Recommendation)	
Temperature Minimum:	100° C
Temperature Maximum:	150° C
Preheat Time:	60-180 seconds
Solder Pot Temperature:	280° C Maximum
Solder Dwell Time:	2-5 seconds

Soldering Parameters - Hand Soldering

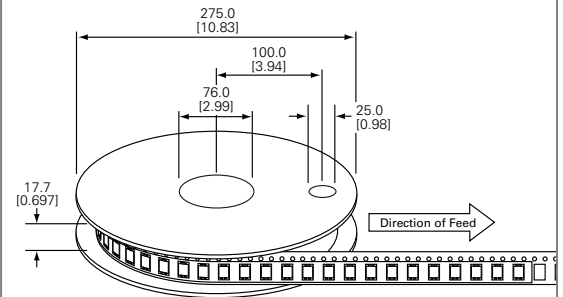
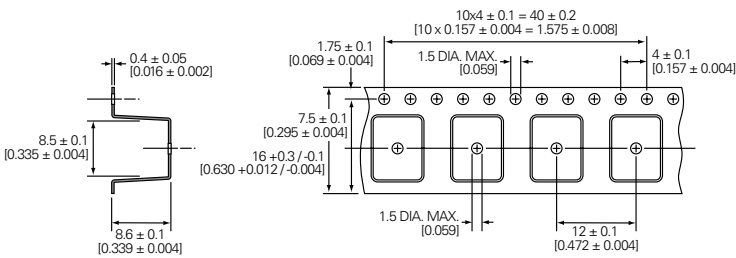
Solder Iron Temperature: 350° C +/- 5°C
Heating Time: 5 seconds max.

Packaging Dimensions

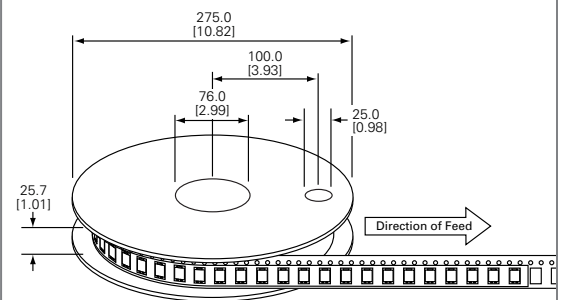
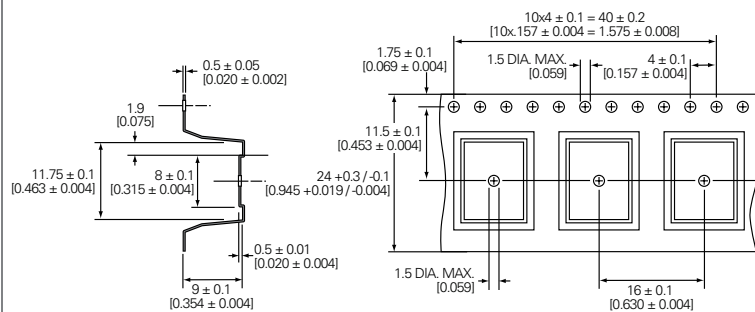
For 'L' Type Axial Lead Items



Core and 'MS' Type Items



For 'LS' Type Shaped Lead Items



Part Numbering System and Ordering Information

CG2 XXX XX * XX													
Series	CG – for 75, 90, or 110V CG2 – for 145V to 1000V												
Breakdown Voltage	<table> <tr><td>75</td><td>300</td></tr> <tr><td>90</td><td>350</td></tr> <tr><td>110</td><td>470</td></tr> <tr><td>145</td><td>600</td></tr> <tr><td>230</td><td>800</td></tr> <tr><td>250</td><td>1000</td></tr> </table>	75	300	90	350	110	470	145	600	230	800	250	1000
75	300												
90	350												
110	470												
145	600												
230	800												
250	1000												
Lead Option Code	(Blank) = No Leads / Core L = Straight Leads LS = Shaped Leads MS = Surface Mount												
Option Code*	SN = may have different DC Breakover Voltage Limit. Please refer to Electrical Characteristics table for additional information.												
Packaging Option Code	(Blank) = No Leads / Core, Bulk Bag - 400 pcs L(Blank) = Straight Lead, Tray - 50 pcs LTR = Straight Lead, Tape & Reel per EIA RS-296-E - 500 per reel LTE = Straight Lead, Tape & Reel per IEC 60286-1 - 500 per reel LS(Blank) = Shaped Lead (see LS dimensions), Tape & Reel - 500 per reel												

Examples:

CG75 – A non-leaded 75V device

CG2230L – A leaded 230V device

CG2800LTR – A leaded 800V device, tape-and-reel (per EIA standard RS-296-D)

Notes:

CG/CG2 devices with other breakdown voltages in the 75-1000 V range are available upon request.

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9